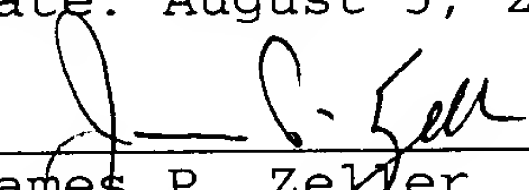




2014  
#11d Amdt.  
M. Brunson  
8/15/02  
PATENT

Atty. Docket No. 29347/990488

IN THE UNITED STATES PATENT  
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	)	
Group Art Unit: 2814	)	
	)	James P. Zeller
Examiner: DiLinh Nguyen	)	Reg. No. 28,491

AMENDMENT "A"

COMMISSIONER FOR PATENTS  
Washington, DC 20231

Sir:

In response to the official action mailed on May 3, 2002,  
please enter the following amendments and consider the  
accompanying remarks.

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